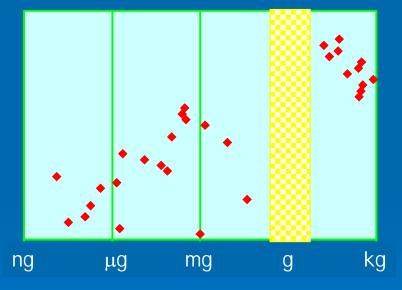
## Science and Technology of Large Mass Bolometer Array

#### Chiara Brofferio University of Milano-Bicocca

#### How to define Large Mass Bolometers



Arrays: more than 10 identical channels

Many differences, but also many common aspects

Chiara Brofferio

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### Searches for Rare Events

(Double Beta Decay, Dark Matter, Axions)

#### Main requirements:

Large mass
 Low Background
 High energy resolution
 Low threshold
 High efficiency
 Long measuring time



- + vast material choice
- + high energy sensitivity
- + calorimetric approach
- + possible double readout
- + LARGE MASS (ARRAYS)
- slowness (in some cases)
- cost
- operation difficulties
- dead time (duty cycle)

## Practical requirements

Technological aspects to be fulfilled



Material selection and background reduction  $\neq$  physics  $\rightarrow \neq$  goals

**Detector design** Optimizing it, taking care also of the other requirements

Array design and assembly

**Reproducibility** a MUST if you work with arrays

Vibrational noise reduction Cryostats are not a "silent world"

**Readout** for a big number of channels

Cryogenics Cooling down large masses

Long term (years) stability and high duty-cycle must compete with "standard techniques"

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## Background reduction

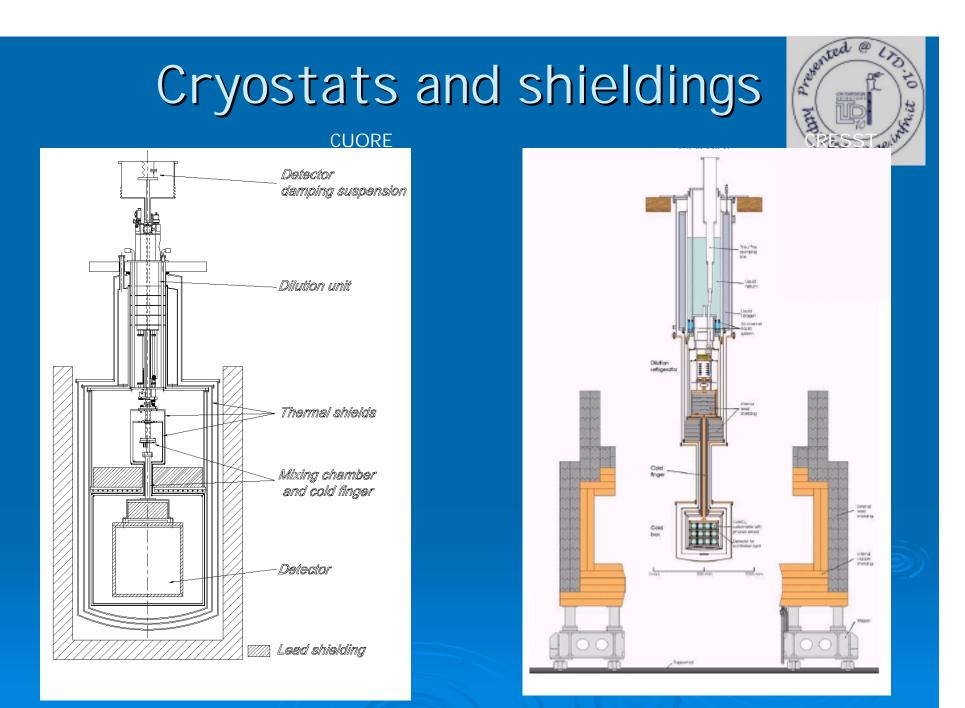


Where does it come from ?

- Cosmic ray interactions and induced activities
- Environmental radiation
- Residual impurities in the construction materials
- Radon and its progenies
- Neutrons from environmental radioactivity

#### How to get rid of it ?

- Deep underground laboratories also to store materials!
- □ Passive and active shieldings
- $\Box$  Material choice and treatment (  $\alpha$  ! )
- □ Background identification If different from the expected signal

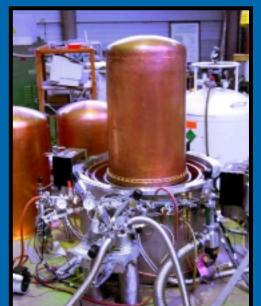


## Cryostats and shieldings

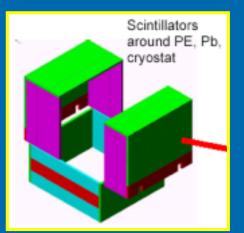




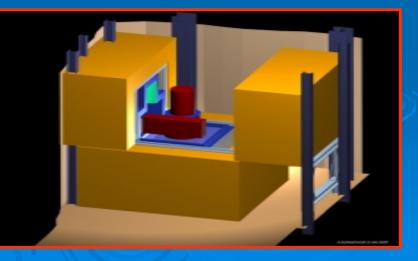
CDMS: a lateral I CE BOX



EDELWEISS A reverse cryostat



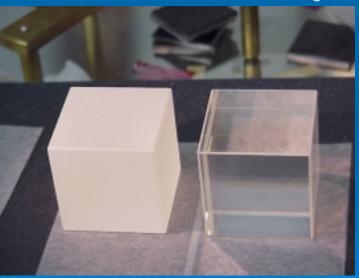




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## Surface treatments

	Tumbling
	Electro-polishing
Lapping and polishing	Chemical etching
Chemical Etching	Plasma sputtering
lon-gun sputtering	I on-gun cleaning
	He conditioning







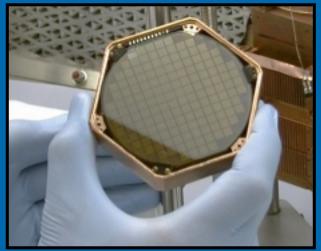
#### WHENEVER YOU USE SOME MATERIAL TO CLEAN, IT HAS TO BE EXTREMELY PURE

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### Detector designs

#### CDMS



CRESST

TES sensors or NTD thermistors

ionization or scintillation

stack of individual detectors or single segmented bolometer

copper and teflon small conductance to heat sink good thermal contact S-A



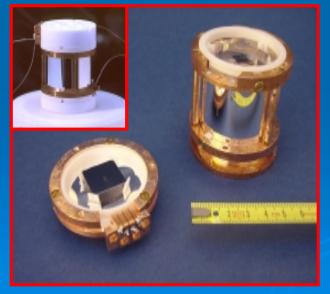
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#### **CUORICINO**





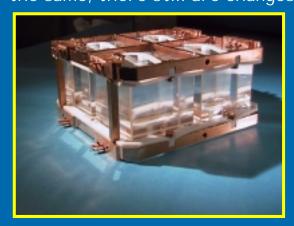
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# Detector mounting evolutio

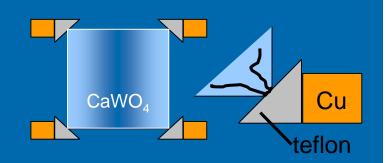


Even if the basic idea remains the same, there still are changes

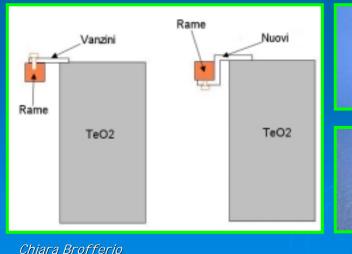




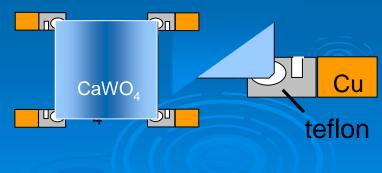
CRESST



CUORICINO







## Array structures (present)



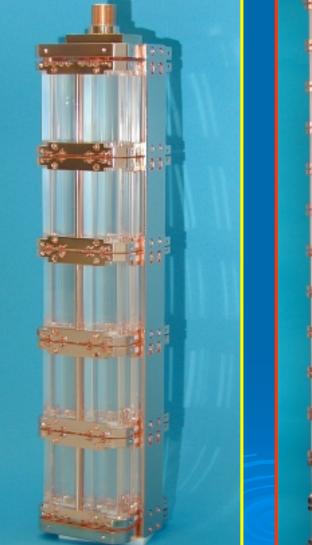
Modularity

Optimization for (anti)coincidence techniques

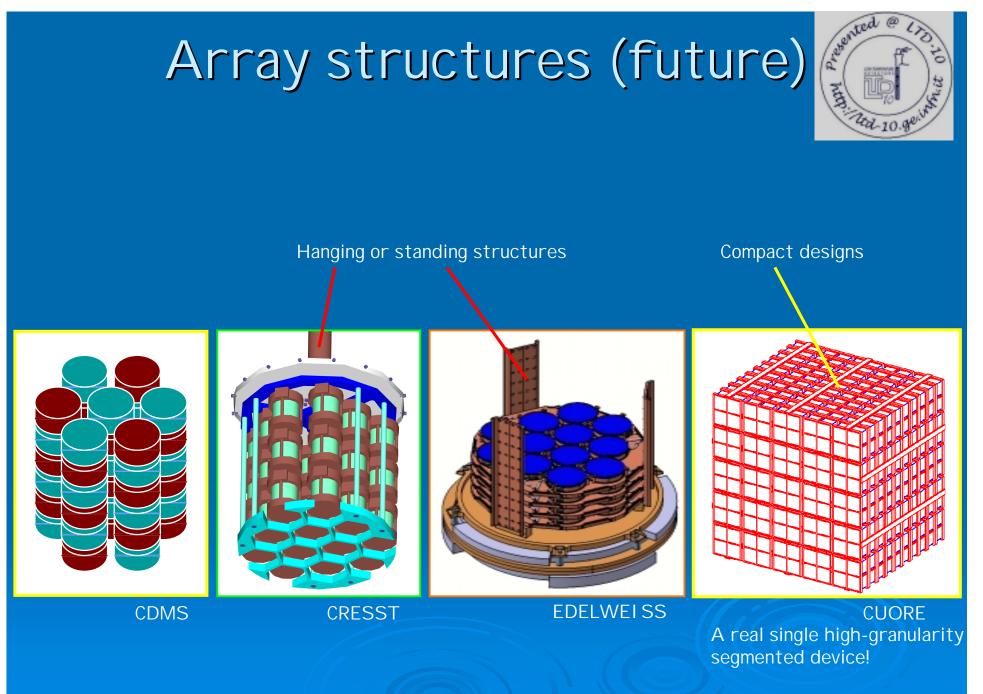
Edelweiss



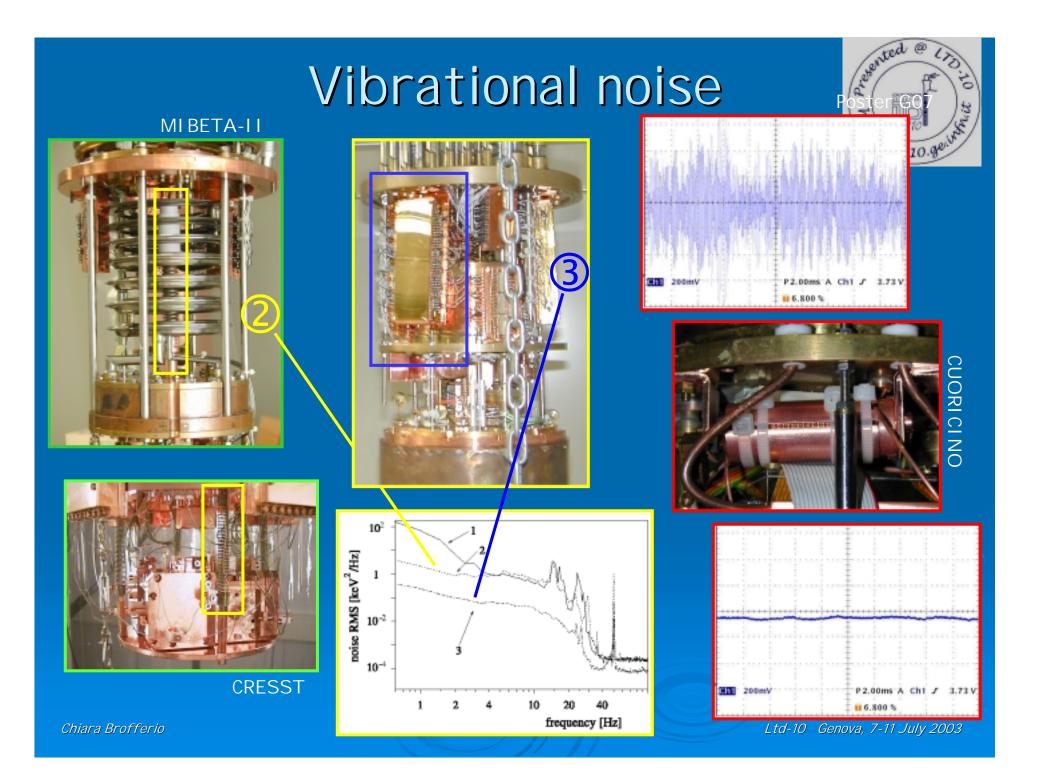








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#### CUORICINO



## Wiring

150 wires, 1500 solders...



Difficult to assemble so many wires in a clean environment!

## Material choice always critical from a thermal and from a radioactive point of view



CUORICINO



CRESST-II



CDMS-II

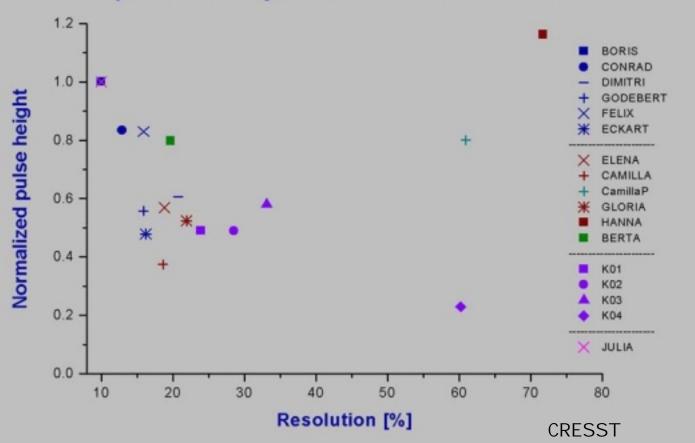
Heat load, SQUIDs, multiplexing...

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## Reproducibility

#### STILL FAR TO BE REALLY UNDER CONTROL

Comparison of crystals - <sup>137</sup>Cs 661.6keV line



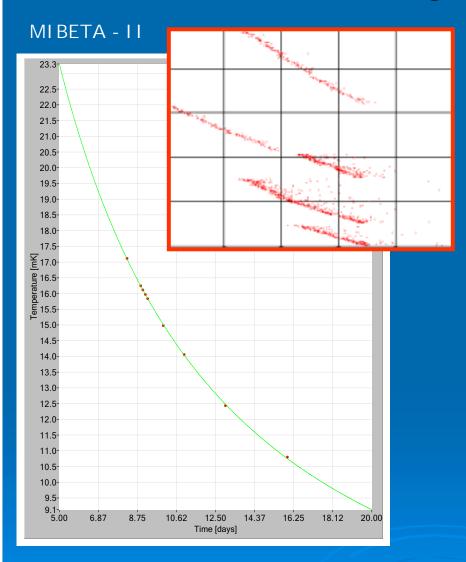
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MAR

## 100-1000 kg COOLDOWN.



#### MIBETA-II



Cooling down of large Cu mass: H-problem

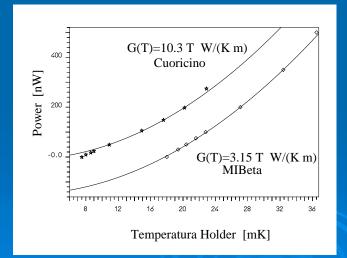
→ 1 month drift before base temperature

#### CUORICINO

Better copper thermalization 🕂

Cooldown stopped at around 20 Kelvin for 2 days.

Detectors quickly at base temperature and no more annoying drift of the operating points.



TON MASSES WILL REQUIRE EVEN MORE STUDIES, ON THE BASIS OF G. A. KNOW-HOW

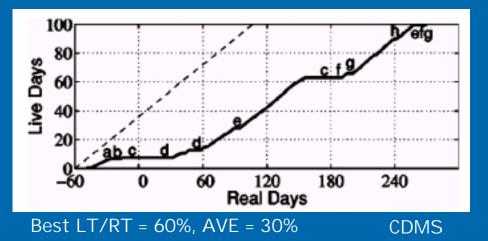
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### Live Time vs Real Time

To be really competitive with the "conventional" techniques, L.T. must as high as possible



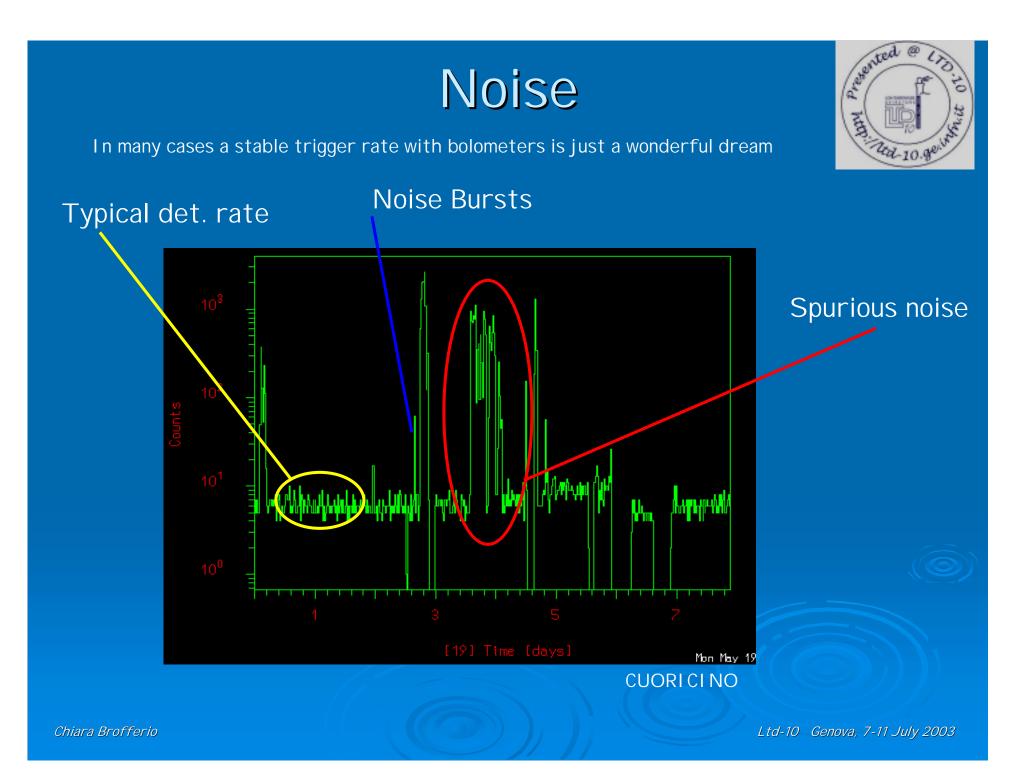


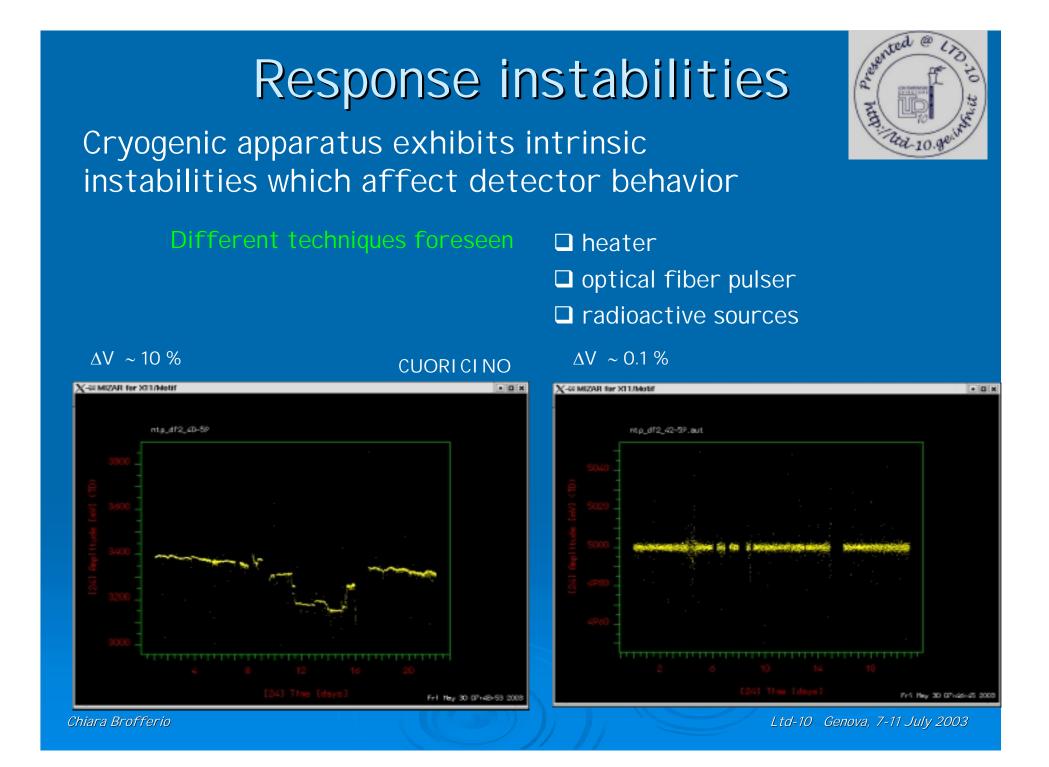
Cryogenic setup
 maintenance stops
 accidental stops
 ... long recovery times

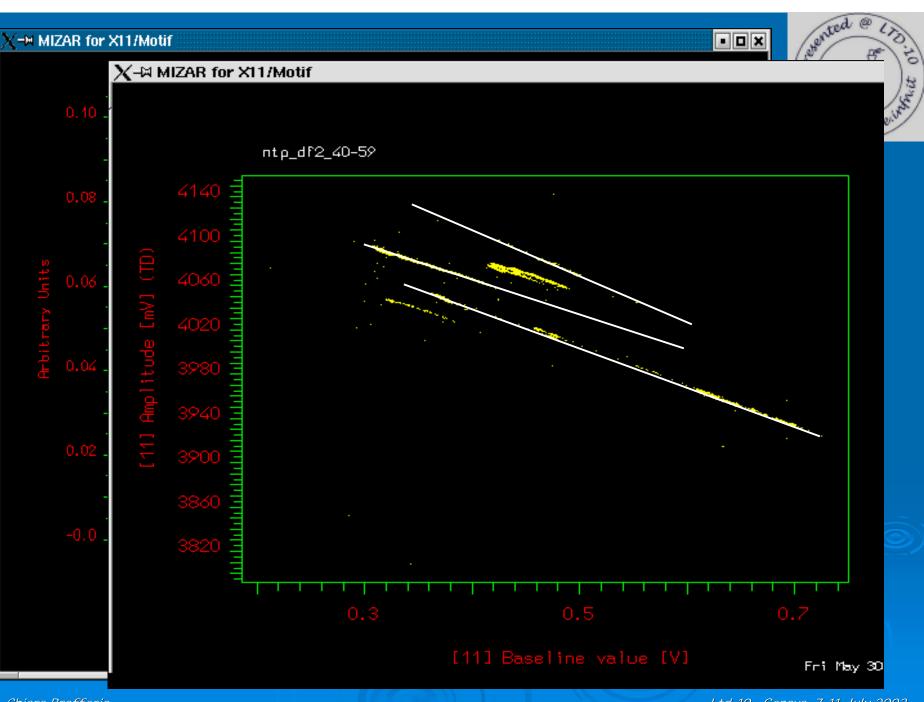
 (1-2 months if warmed up)

To fight against all this

- Highly reliable electronics and data acquisition
- Cryogenic system regular maintenance
- System spares
- Avoid refillings
- Optimize calibration sources and efficiencies
- Eliminate spurious noises







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